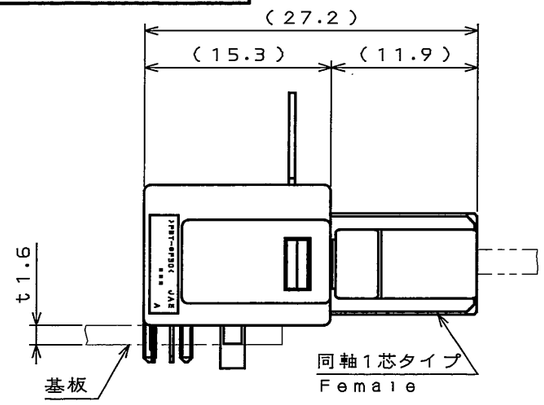
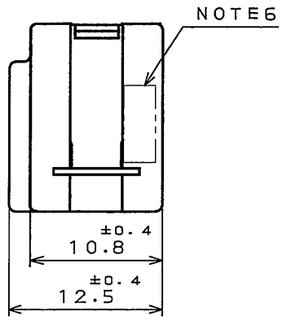
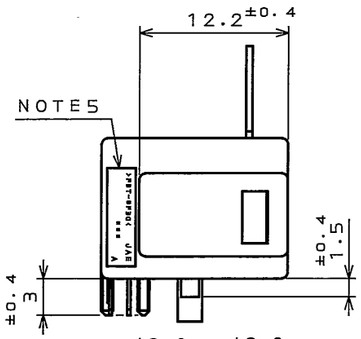
版数 REV.	年月日 DATE	DCN NO.	変更内容 DESCRIPTION	製図 DR.	担当 CHK.	査閲 APPD.	承認 APPD.

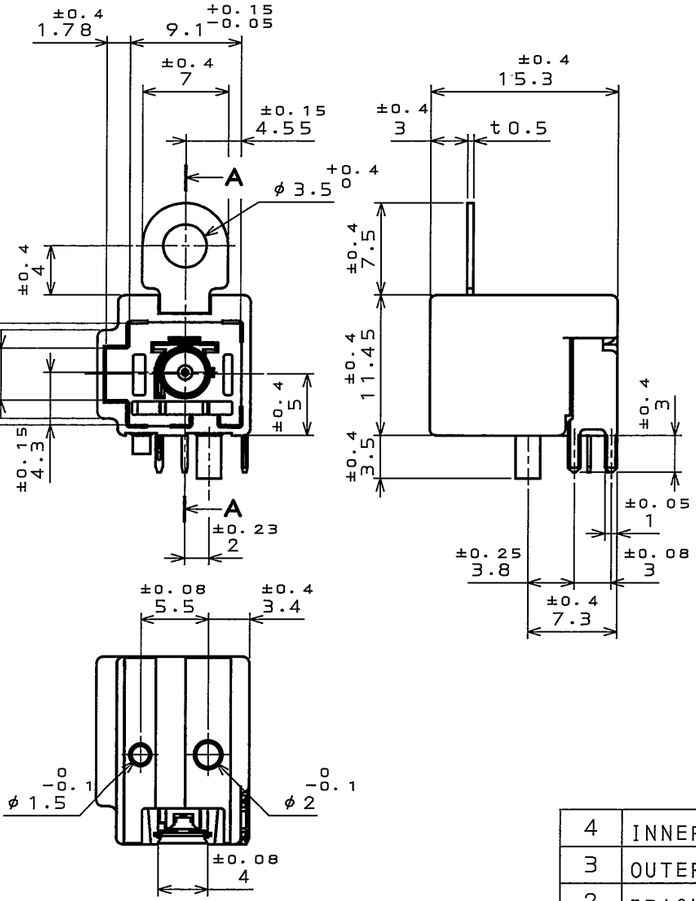
図面番号(DRAWING NO.) SJ107323

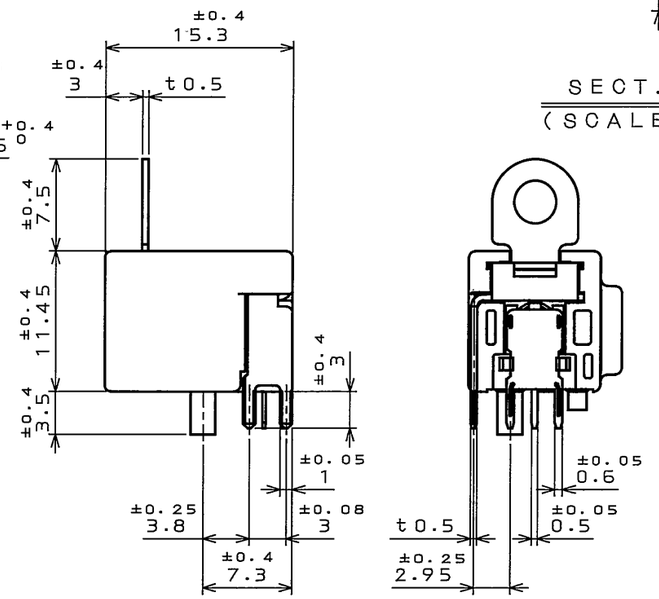


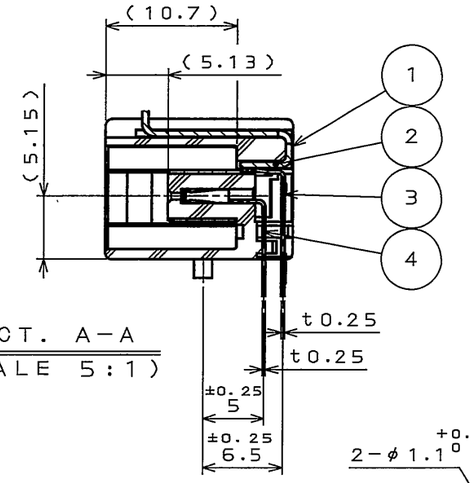


MATED CONDITION(REF.)
嵌合状態図(参考)

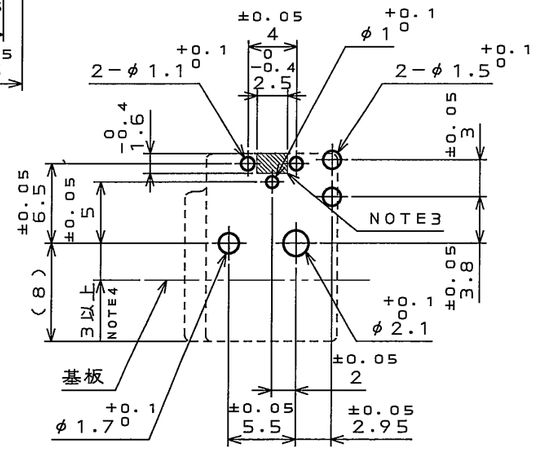




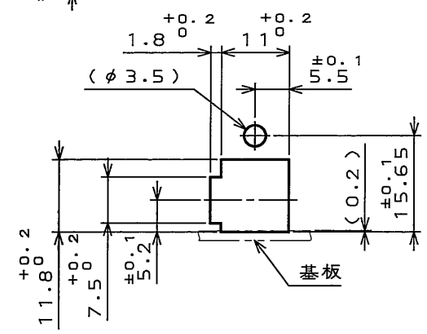




SECT. A-A
(SCALE 5:1)



P.C.B. LAYOUT・MOUNTING SIDE(REF.)
基板取付穴寸法(参考・装着面)



PANEL HOLE PATTERNS(REF.)
パネル取付穴寸法(参考)

NOTE1.APPLICABLE P.C.B THICKNESS : 1.6mm
2.APPLY THE HEAT TO MELT RIB, SO THAT THE RIB MAY STICK FIRMLY TO P.C.B. WITHOUT LEAVING SPACE BETWEEN THEM.
3.PATTERN PROHIBITION AREA(CONNECTOR MOUNTING SIDE)
4.THE DISTANCE SHALL BE MORE THAN 3mm WHEN HEATING TO MELT RIB.
5.COMPANY LOGO "JAE",MOLD CAVITY DESIGHNATOR AND MAETRIAL MARKS "PBT-GF30" IS INDICATED AS SHOWN.
6.THE ASSEMBLY LOT NO. IS INDICATED AS SHOWN.

注1.適合基板厚:1.6mm
2.溶着用レグは基板裏側から基板との浮きが無いよう確実に溶着し固定すること。
3.パターン禁止区域(コネクタ実装面)
4.レグ溶着時は3mm以上であること。
5.図示の位置に社標、金型マーク、材料名の表示を行う。
6.図示の位置に組立ロット　の表示を行う。

符号 NO.	名称 DESCRIPTION	個数 QTY.	材料 MATERIAL	仕上 FINISH	備考 REMARKS
4	INNER TERMINAL	1	COPPER ALLOY	SELECTIVE GOLD PLATING SELECTIVE TIN PLATING	
3	OUTER TERMINAL	1	COPPER ALLOY	TIN PLATING	
2	BRACKET	1	COPPER ALLOY	TIN PLATING	
1	HOUSING	1	GF PBT	(COLOR:LIGHT GRAY)	

仕様書(SPECIFICATION) JACS-20084

第1版(ORIGINAL DATE) 10.May.2007

一般公差(GENERAL TOLERANCE)

寸法(DIMENSION)	角度(ANGLES)
. ±0.8	X° ±
.X ±0.4	X°X' ±
.XX ±0.1	
.XXX±	

製図 DR.	
担当 CHK.	H.MIZUSHINA
査閲 APPD.	T.MIYASHITA
承認 APPD.	Y.Sugii
—	

尺度(SCALE) 2:1

シリーズ(SERIES) CE2

名称(TITLE) CE2S101C02

質量(MASS)

日本航空電子工業株式会社
JAPAN AVIATION ELECTRONICS INDUSTRY, LTD.

SIZE A3

図面番号(DRAWING NO.) SJ107323

版数(REV.) 1

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JAE-CONNECTOR.COM Reference Only

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